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**Passive RF and microwave devices, intermodulation level measurement –
Part 1: General requirements and measuring methods**

**Dispositifs RF et à micro-ondes passifs, mesure du niveau d'intermodulation –
Partie 1: Exigences générales et méthodes de mesure**



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**PASSIVE RF AND MICROWAVE DEVICES,
INTERMODULATION LEVEL MEASUREMENT –****Part 1: General requirements and measuring methods**

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IEC 62037-1 has been prepared by IEC technical committee 46: Cables, wires, waveguides, RF connectors, RF and microwave passive components and accessories. It is an International Standard.

This second edition cancels and replaces the first edition published in 2012. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) clarification added that test equipment may utilize pulsed generators to reduce power consumption;
- b) heating effect differences in the device under test noted in Annex B for tests conducted using pulsed generators;
- c) guidance added in Annex B to improve probability of detection of short duration PIM events while dynamic testing.

The text of this International Standard is based on the following documents:

Draft	Report on voting
46/834/FDIS	46/855/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at www.iec.ch/members_experts/refdocs. The main document types developed by IEC are described in greater detail at www.iec.ch/standardsdev/publications.

This International Standard is to be used in conjunction with IEC 62037 (all parts).

A list of all the parts in the IEC 62037 series, published under the general title *Passive RF and microwave devices, intermodulation level measurement*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under webstore.iec.ch in the data related to the specific document. At this date, the document will be

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PASSIVE RF AND MICROWAVE DEVICES, INTERMODULATION LEVEL MEASUREMENT –

Part 1: General requirements and measuring methods

1 Scope

This part of IEC 62037 deals with the general requirements and measuring methods for intermodulation (IM) level measurement of passive RF and microwave components, which can be caused by the presence of two or more transmitting signals.

The test procedures given in this document give the general requirements and measurement methods required to characterize the level of unwanted IM signals using two transmitting signals.

The IEC 62037 series addresses the measurement of PIM, but does not cover the long-term reliability of a product with reference to its performance.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62037 (all parts), *Passive RF and microwave devices, intermodulation level measurement*

3 Terms, definitions and abbreviated terms

3.1 Terms and definitions

No terms and definitions are listed in this document.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at <http://www.electropedia.org/>
- ISO Online browsing platform: available at <http://www.iso.org/obp>

3.2 Abbreviated terms

CATV	Community antenna television
CFEC	Carbon fibre epoxy composite
CW	Continuous wave
DUT	Device under test
IM	Intermodulation
PCB	Printed circuit board
PIM	Passive intermodulation
RBW	Resolution bandwidth
VDA	Vacuum deposited aluminium